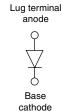


Vishay High Power Products

HEXFRED® Ultrafast Soft Recovery Diode, 275 A







PRODUCT SUMMARY				
I _F (maximum)	275 A			
V_{R}	400 V			
I _{F(DC)} at T _C	138 A at 100 °C			

FEATURES

- · Very low Q_{rr} and t_{rr}
- · Lead (Pb)-free
- · Designed and qualified for industrial level



ROHS

BENEFITS

- · Reduced RFI and EMI
- · Reduced snubbing

DESCRIPTION

HEXFRED® diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dI/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V_R		400	V	
Continuous forward current	I _F	T _C = 25 °C	275		
Continuous forward current		T _C = 100 °C	138	А	
Single pulse forward current	I _{FSM}	Limited by junction temperature	900		
Non-repetitive avalanche energy	E _{AS}	$L = 100 \mu H$, duty cycle limited by maximum T_J	1.4	mJ	
Maximum newer dissination	P _D	T _C = 25 °C	463	W	
Maximum power dissipation		T _C = 100 °C	185] vv	
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	Ι _R = 100 μΑ		400	-	-	
Maximum forward voltage	V _{FM}	I _F = 135 A	See fig. 1	-	1.06	1.65	V
		I _F = 270 A		=	1.2	2.0	
		I _F = 135 A, T _J = 125 °C		-	0.96	1.58	
Maximum reverse leakage current	I _{RM}	T _J = 125 °C, V _R = 400 V	See fig. 2	-	-	3	mA
Junction capacitance	C _T	V _R = 200 V	See fig. 3	=	280	380	pF
Series inductance	L _S	From top of terminal hole to mounting plane - 6.		6.0	-	nH	

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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS	
Reverse recovery time		T _J = 25 °C		-	77	120	no
See fig. 5	t _{rr}	T _J = 125 °C		-	280	440	ns
Peak recovery current		T _J = 25 °C	I _F = 135 A dI _F /dt = 200 A/μs V _B = 200 V	-	7.5	14	А
See fig. 6	IRRM	T _J = 125 °C		-	15	30	
Reverse recovery charge	0	T _J = 25 °C		-	150	780	nC
See fig. 7	T _J = 125 °C	H 22	-	2800	6300	lic	
Peak rate of recovery current See fig. 8	dl/dt	T _J = 25 °C		-	350	ı	A/μs
	dI _{(rec)M} /dt	T _J = 125 °C		-	300	-	Α/μδ

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and stemperature range	storage	T _J , T _{Stg}		- 55 to 150 °C		
Maximum thermal resistance, junction to case		R _{thJC}	DC operation See fig. 4	0.27	°C/W	
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, flat, smooth and greased	0.05	· C/VV	
Approximate weight	A managina ata garaint			30	g	
Approximate weight				1.06	OZ.	
Mounting torque	minimum			3 (26.5)		
Mounting torque	maximum			4 (35.4)	N⋅m	
Terminal torque	minimum			3.4 (30)	(lbf ⋅ in)	
	maximum			5 (44.2)		
Case style			HALF-PAK module			





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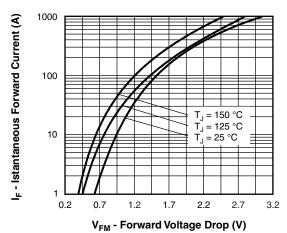


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

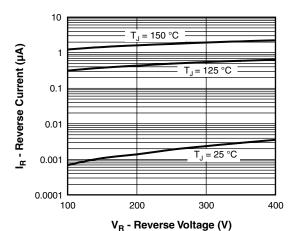


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

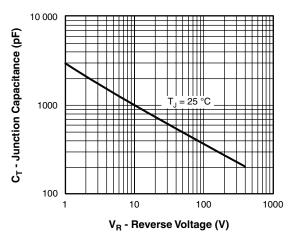


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

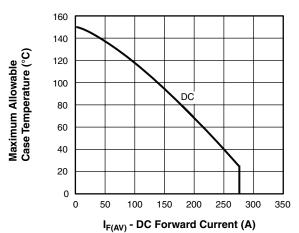


Fig. 4 - Maximum Allowable Case Temperature vs. DC **Forward Current**

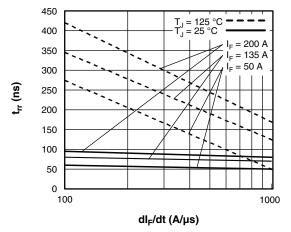


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt

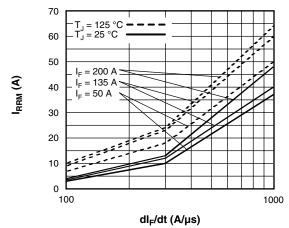


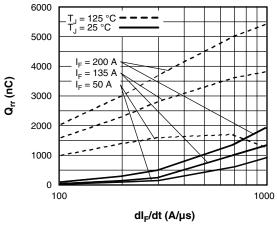
Fig. 6 - Typical Recovery Current vs. dl_F/dt

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dl_F/dt (A/μs) Fig. 7 - Typical Stored Charge vs. dl_F/dt

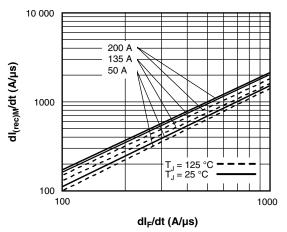


Fig. 8 - Typical dI_{(rec)M}/dt vs. dI_F/dt

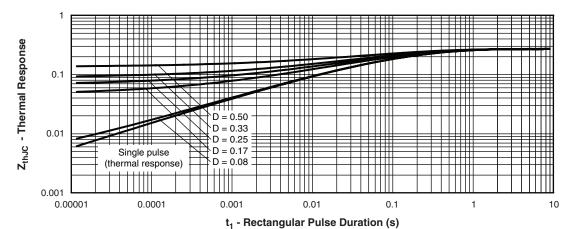


Fig. 9 - Maximum Thermal Impedance Z_{thJC} Characteristics



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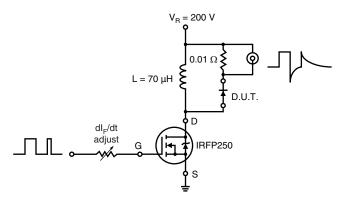
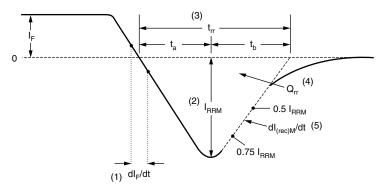


Fig. 10 - Reverse Recovery Parameter Test Circuit



- (1) dI_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $\rm t_{rr}$ reverse recovery time measured from zero crossing point of negative going $\rm I_F$ to point where a line passing through 0.75 $\rm I_{RRM}$ and 0.50 $\rm I_{RRM}$ extrapolated to zero current.
- (4) $\mathbf{Q}_{\rm rr}$ area under curve defined by $\mathbf{t}_{\rm rr}$ and $\mathbf{I}_{\rm RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) dI_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 11 - Reverse Recovery Waveform and Definitions

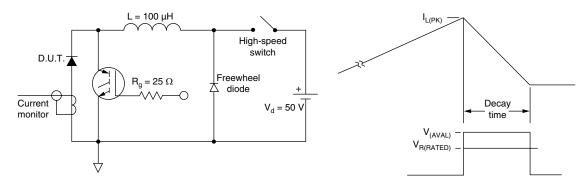


Fig. 12 - Avalanche Test Circuit and Waveforms

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ORDERING INFORMATION TABLE

Device code

HFA 135 N H 40 PbF

1 2 3 4 5 6

1 - HEXFRED® family
2 - Average current rating
3 - N = Not isolated

4 - H = HALF-PAK

5 - Voltage rating (400 V)

6 - Lead (Pb)-free

LINKS TO RELATED DOCUMENTS				
Dimensions http://www.vishay.com/doc?95020				

Document Number: 94050 Revision: 01-Aug-08

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